

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT7506373

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TAKATOSHI NAKAMURA	08/28/2018
RECEIVING PARTY DATA	
Name:	NTI, INC.
Street Address:	7-4 MATSUTERA 3-CHOME
Internal Address:	YOKKAICHI-SHI
City:	MIE
State/Country:	JAPAN
Postal Code:	5108021
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16065210
CORRESPONDENCE DATA	
Fax Number:	(301)762-4056
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	301-424-3640
Email:	kwiley@esfip.com
Correspondent Name:	EDELL SHAPIRO & FINNAN LLC
Address Line 1:	LAWRENCE D. EISEN
Address Line 2:	9801 WASHINGTONIAN BLVD., SUITE 750
Address Line 4:	GAITHERSBURG, MARYLAND 20878
ATTORNEY DOCKET NUMBER:	2310.0006C
NAME OF SUBMITTER:	LAWRENCE D. EISEN
SIGNATURE:	/Lawrence D. Eisen/
DATE SIGNED:	08/26/2022
Total Attachments: 1	
source=OP160014PCTUS_ExecutedAssignment#page1.tif	

ASSIGNMENT

For good and valuable consideration, I, Takatoshi NAKAMURA, residing at 7-4, Matsutera 3-chome, Yokkaichi-shi, Mie, 5108021 JAPAN; hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to NTL, Inc., having its principal place of business at 7-4, Matsutera 3-chome, Yokkaichi-shi, Mie, 5108021 JAPAN, hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and entitled:

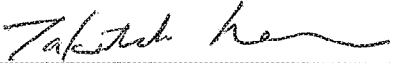
Settlement System, User Terminal and Method Executed Thereby, Settlement Device and Method Executed Thereby, and Program

filed on June 22, 2018 as U.S. Application Serial No. 16/065,210,

and in and to said application, including, without prejudice to the generality of the foregoing, the right to file applications and to obtain patents or like protection in any country throughout the World, including the right to claim priority from any such application, and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE:  DATE: August 28, 2018
Takatoshi NAKAMURA